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-	286	428/28.ccls.	USPAT;	2002/06/18 13:41
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-	3	4490440.pn.	USPAT;	2002/06/18 15:12
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- 19989 silicon and diamond) and wafer USPAT; USPGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT; USPAT USPAT USPAT USPAT USPAT USPAT USPAT USPAT; USP	6/18 16:10 6/18 16:20 6/18 16:20
- 71 (((CVD and diamond\$2) and layer) and substrate\$2) and USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPAT USPA	
- 19989 silicon and diamond and wafer 19989	
- 71 (((CVD and diamond\$2) and layer) and substrate\$2) and (gem\$7 or jewelry) - 19989 silicon and diamond - 19989 silicon and diamond - 4964 (silicon and diamond) and wafer - 4964 (silicon and diamond) and wafer - 1560 ((silicon and diamond) and wafer) and CVD - 1560 ((silicon and	
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- 123 corundum near3 layer IBM_TDB USPAT; 2002/0	5/18 17:02
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- 80 CVD and corundum IBM_TDB USPAT; 2002/0	6/18 17:03
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